**Preliminary** 

TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

# MT6L58AS

VHF-UHF Band Low Noise Amplifier Application VHF-UHF Band Oscillator Application

 Two devices are built into the sES6 package, which is smaller and thinner than the super-thin and ultra-super mini (6-pin) ES6 package.

#### **Mounted Devices**

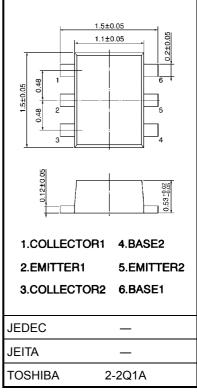
	Q1: SSM (TESM)	Q2: SSM (TESM)
Three pin (SSM/TESM) type part No.	MT3S06S (MT3S06T)	MT3S03AS (MT3S03AT)

#### Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Q1	Q2	Unit
Collector-base voltage	$V_{CBO}$	10	10	V
Collector-emitter voltage	$V_{CEO}$	5	5	V
Emitter-base voltage	$V_{EBO}$	1.5	2	V
Collector current	IC	15	40	mA
Base current	ΙΒ	7	10	mA
Collector power dissipation	P <sub>C</sub> (Note 1)	150		mW
Junction temperature	Tj	125		°C
Storage temperature range	T <sub>stg</sub>	-55~125		°C

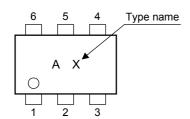
Note 1: Total power dissipation of Q1 and Q2 mounted on the circuit board.

#### Unit: mm

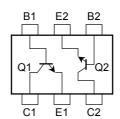


Weight: 2.1 mg

## Marking



#### **Pin Assignment**



## **Electrical Characteristics Q1-Side (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_	_	0.1	μА
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = 1 \text{ V, } I_C = 0$	_	_	1	μА
DC current gain	h <sub>FE</sub>	$V_{CE} = 1 \text{ V, } I_{C} = 5 \text{ mA}$	70	_	140	_
Transition frequency	f <sub>T</sub>	$V_{CE} = 3 \text{ V}, I_{C} = 5 \text{ mA}$	7	10	_	GHz
Insertion gain	S <sub>21e</sub>   <sup>2</sup> (1)	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	7.5	_	dB
	S <sub>21e</sub>   <sup>2</sup> (2)	$V_{CE} = 3 \text{ V}, I_{C} = 7 \text{ mA}, f = 2 \text{ GHz}$	4.5	8.3	_	
Noise figure	NF (1)	$V_{CE} = 1 \text{ V}, I_{C} = 3 \text{ mA}, f = 2 \text{ GHz}$	_	1.7	3	- dB
	NF (2)	$V_{CE} = 3 \text{ V}, I_{C} = 3 \text{ mA}, f = 2 \text{ GHz}$	_	1.6	3	
Reverse transfer capacitance	C <sub>re</sub>	$V_{CB} = 1 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ (Note 2)	_	0.35	0.75	pF

## **Electrical Characteristics Q2-Side (Ta = 25°C)**

Characteristics	Symbol	Test Condition		Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 5 \text{ V}, I_{E} = 0$	_		0.1	μΑ
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = 1 \text{ V, } I_{C} = 0$	_	_	1	μΑ
DC current gain	h <sub>FE</sub>	$V_{CE} = 1 \text{ V, } I_{C} = 5 \text{ mA}$	80	_	160	_
Transition frequency	f <sub>T</sub> (1)	$V_{CE} = 1 \text{ V, } I_{C} = 5 \text{ mA}$	5	7	_	GHz
	f <sub>T</sub> (2)	$V_{CE} = 3 \text{ V}, I_{C} = 10 \text{ mA}$	7	10	_	
Insertion gain	S <sub>21e</sub>   <sup>2</sup> (1)	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	5	_	dB
	S <sub>21e</sub>   <sup>2</sup> (2)	$V_{CE} = 3 \text{ V}, I_{C} = 20 \text{ mA}, f = 20 \text{ GHz}$	3	6.8	_	
Noise figure	NF (1)	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	1.7	3	dB
	NF (2)	$V_{CE} = 3 \text{ V}, I_{C} = 7 \text{ mA}, f = 2 \text{ GHz}$	_	1.4	2.2	
Reverse transfer capacitance	C <sub>re</sub>	$V_{CB} = 1 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ (Note 2)	—	0.8	1.15	pF

Note 2:  $C_{\text{re}}$  is measured by 3 terminal method with capacitance bridge.

## **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

2

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